

Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on) \max}$ | I_D $T_A = +25^\circ\text{C}$ |
|---------------|--------------------------------|------------------------------------|
| -20V | 35mΩ @ $V_{GS} = -4.5\text{V}$ | -6.0A |
| | 45mΩ @ $V_{GS} = -2.5\text{V}$ | -5.2A |

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

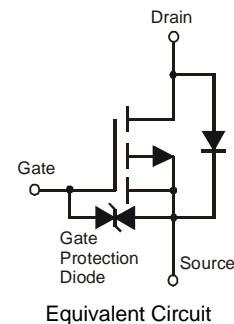
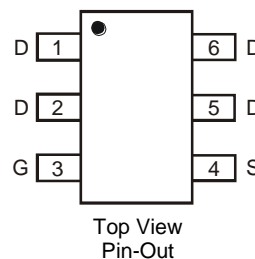
- DC-DC Converters
- Motor Control
- Power management functions
- Analog Switch

Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- ESD protected Up To 3kV
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.013 grams (Approximate)

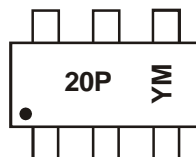


Ordering Information (Note 5)

| Part Number | Case | Packaging |
|----------------|--------|--------------------|
| DMP2035UVTQ-7 | TSOT26 | 3,000/Tape & Reel |
| DMP2035UVTQ-13 | TSOT26 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q10x qualified and are PPAP capable. Automotive, AEC-Q10x and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



20P = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: Y = 2011)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 |
|------|------|------|------|------|------|------|------|
| Code | Y | Z | A | B | C | D | E |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | | | Symbol | Value | Units |
|---|--------------|--|------------------|--------------|-------|
| Drain-Source Voltage | | | V _{DSS} | -20 | V |
| Gate-Source Voltage | | | V _{GSS} | ±12 | V |
| Continuous Drain Current (Note 7) V _{GS} = -4.5V | Steady State | T _A = +25°C T _A = +70°C | I _D | -6.0 -4.8 | A |
| | t < 10s | T _A = +25°C T _A = +70°C | I _D | -7.2 -5.7 | A |
| Continuous Drain Current (Note 7) V _{GS} = -2.5V | Steady State | T _A = +25°C T _A = +70°C | I _D | -5.2 -4.1 | A |
| | t < 10s | T _A = +25°C T _A = +70°C | I _D | -6.2 -4.9 | A |
| Maximum Continuous Body Diode Forward Current (Note 7) | | | I _S | -2.0 | A |
| Pulsed Drain Current (10μs pulse, duty cycle = 1%) | | | I _{DM} | -24 | A |

Thermal Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | | Symbol | Value | Units |
|--|--------------|-----------------------------------|------------------|-------|
| Total Power Dissipation (Note 6) | | P _D | 1.2 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | R _{θJA} | 106 | °C/W |
| | t < 10s | | 74 | |
| Total Power Dissipation (Note 7) | | P _D | 2.0 | W |
| Thermal Resistance, Junction to Ambient (Note 7) | Steady State | R _{θJA} | 65 | °C/W |
| | t < 10s | | 46 | |
| Thermal Resistance, Junction to Case (Note 7) | | Steady State | R _{θJC} | 11.8 |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to 150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--|---------------------------------------|------|------|------|-------|---|
| OFF CHARACTERISTICS (Note 8) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -20 | — | — | V | V _{GS} = 0V, I _D = -250μA |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | -1 | μA | V _{DS} = -20V, V _{GS} = 0V |
| Gate-Source Leakage | I _{GSS} | — | — | ±10 | μA | V _{GS} = ±8V, V _{DS} = 0V |
| ON CHARACTERISTICS (Note 8) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | -0.4 | -0.7 | -1.5 | V | V _{DS} = V _{GS} , I _D = -250μA |
| Gate Threshold Voltage Temperature Coefficient | ΔV _{GS(th)} /ΔT _J | — | 2.5 | — | mV/°C | I _D = -250μA, Referenced to +25°C |
| Static Drain-Source On-Resistance | R _{DS(on)} | — | 23 | 35 | mΩ | V _{GS} = -4.5V, I _D = -4.0A |
| | | — | 30 | 45 | | V _{GS} = -2.5V, I _D = -4.0A |
| | | — | 41 | 62 | | V _{GS} = -1.8V, I _D = -2.0A |
| Forward Transfer Admittance | Y _{fs} | — | 18 | — | S | V _{DS} = -5V, I _D = -5.5A |
| Diode Forward Voltage (Note 7) | V _{SD} | — | -0.7 | -1.0 | V | V _{GS} = 0V, I _S = -1A |
| DYNAMIC CHARACTERISTICS (Note 9) | | | | | | |
| Input Capacitance | C _{iss} | — | 1610 | 2400 | pF | V _{DS} = -10V, V _{GS} = 0V f = 1.0MHz |
| Output Capacitance | C _{oss} | — | 157 | 210 | | |
| Reverse Transfer Capacitance | C _{rss} | — | 145 | 200 | | |
| Gate Resistance | R _G | — | 9.4 | 14.1 | Ω | V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz |
| Total Gate Charge | Q _g | — | 15.4 | 23.1 | nC | V _{DS} = -10V, V _{GS} = -4.5V I _D = -4A |
| Gate-Source Charge | Q _{gs} | — | 2.5 | — | | |
| Gate-Drain Charge | Q _{gd} | — | 3.3 | — | | |
| Turn-On Delay Time | t _{D(on)} | — | 17 | 33 | ns | V _{GS} = -4.5V, V _{DS} = -10V, R _G = 6Ω, I _D = -1A, R _L = 10Ω |
| Turn-On Rise Time | t _r | — | 12 | 19 | | |
| Turn-Off Delay Time | t _{D(off)} | — | 94 | 150 | | |
| Turn-Off Fall Time | t _f | — | 42 | 64 | | |
| Reverse Recovery Time | t _{rr} | — | 14 | 25 | ns | I _F = -4.5A, di/dt = 100A/μS |
| Reverse Recovery Charge | Q _{rr} | — | 4 | 8 | nC | |

- Notes:
6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1 inch square copper plate.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.

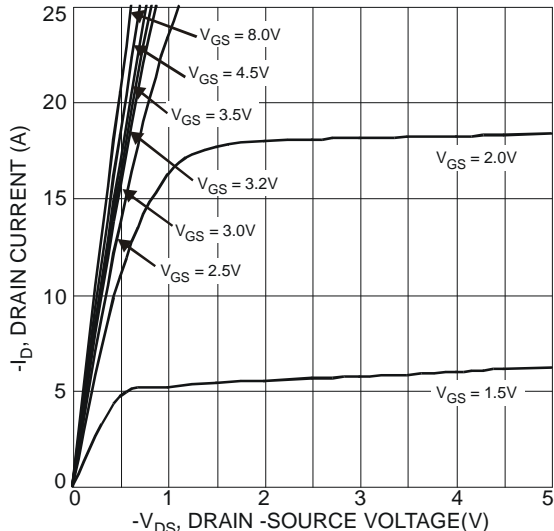


Fig. 1 Typical Output Characteristics

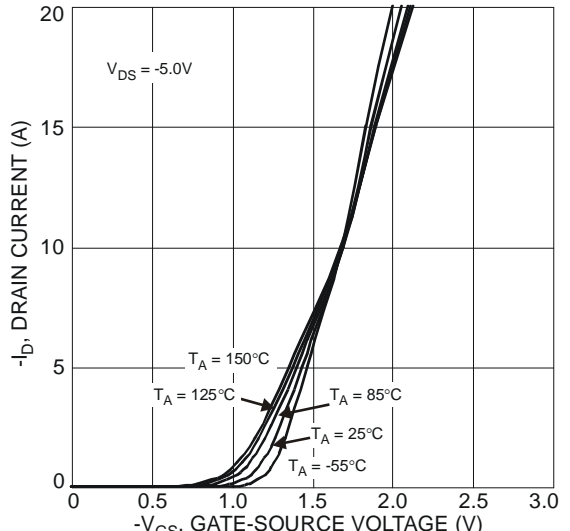


Fig. 2 Typical Transfer Characteristics

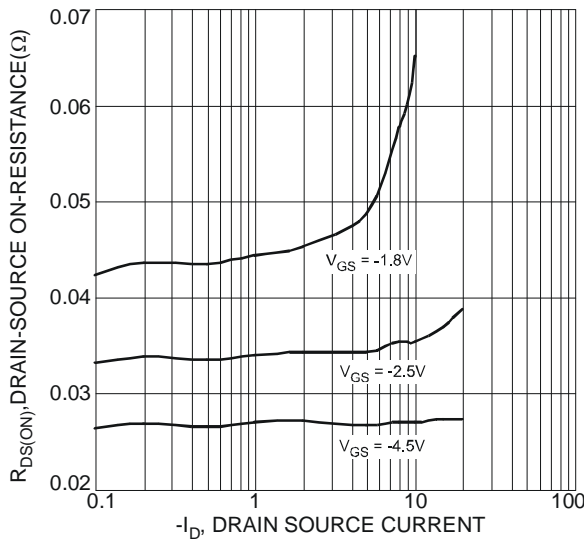


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

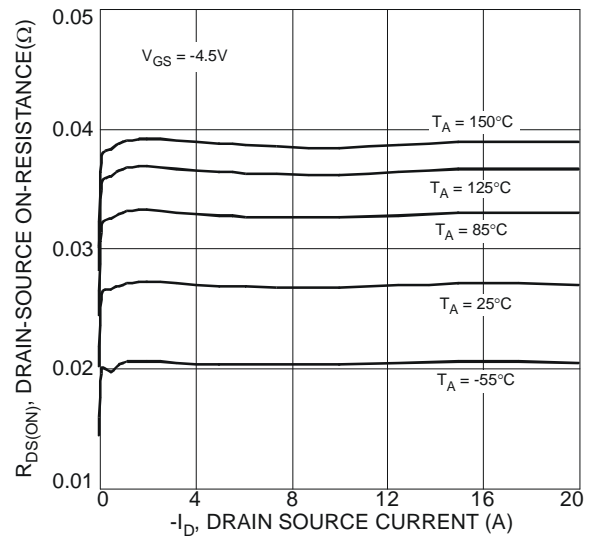


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

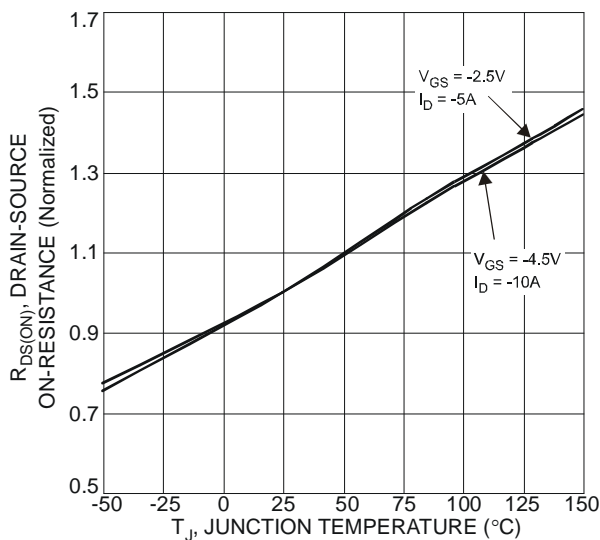


Fig. 5 On-Resistance Variation with Temperature

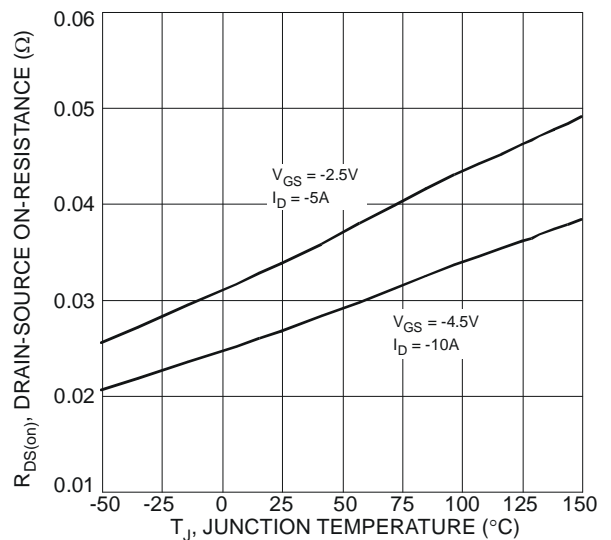


Fig. 6 On-Resistance Variation with Temperature

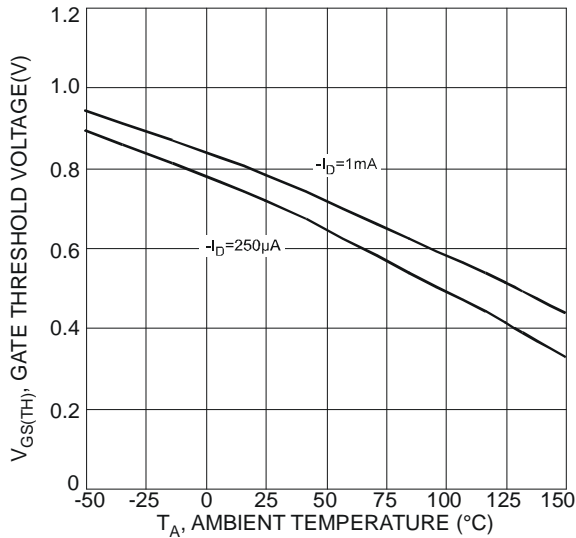


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

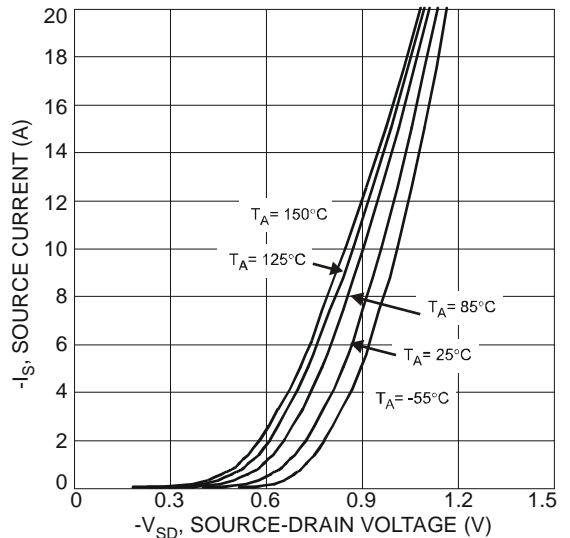


Fig. 8 Diode Forward Voltage vs. Current

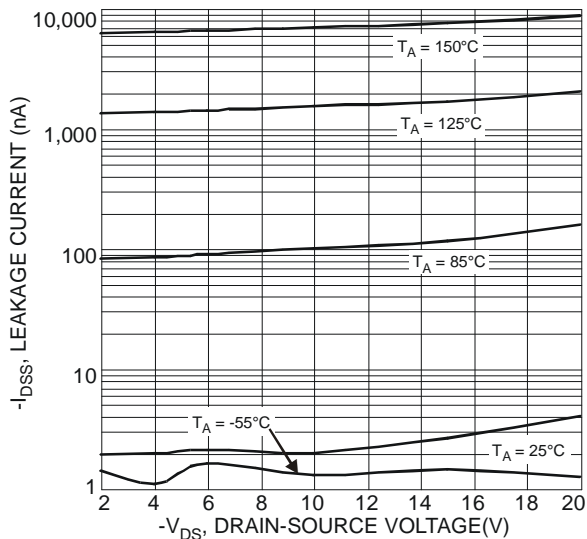


Fig. 9 Typical Drain-Source Leakage Current vs. Voltage

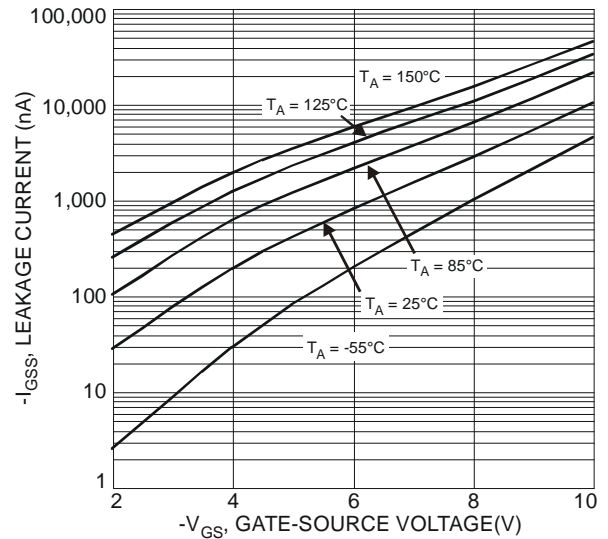


Fig. 10 Typical Gate-Source Leakage Current vs. Voltage

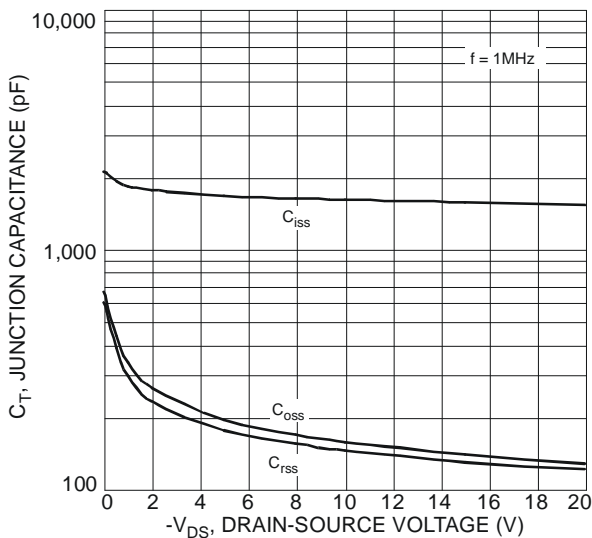


Fig. 11 Typical Junction Capacitance

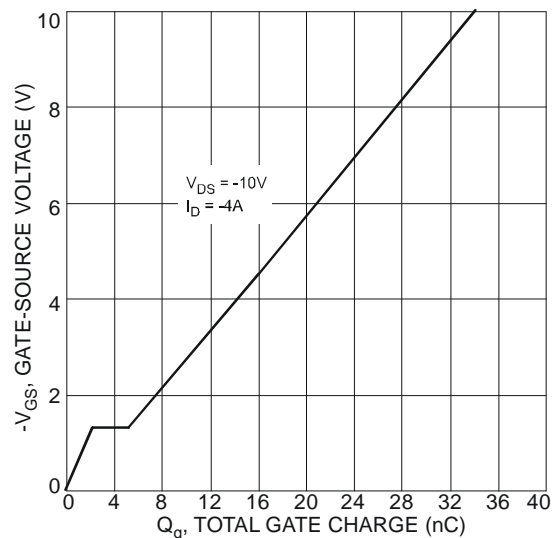


Fig. 12 Gate-Charge Characteristics

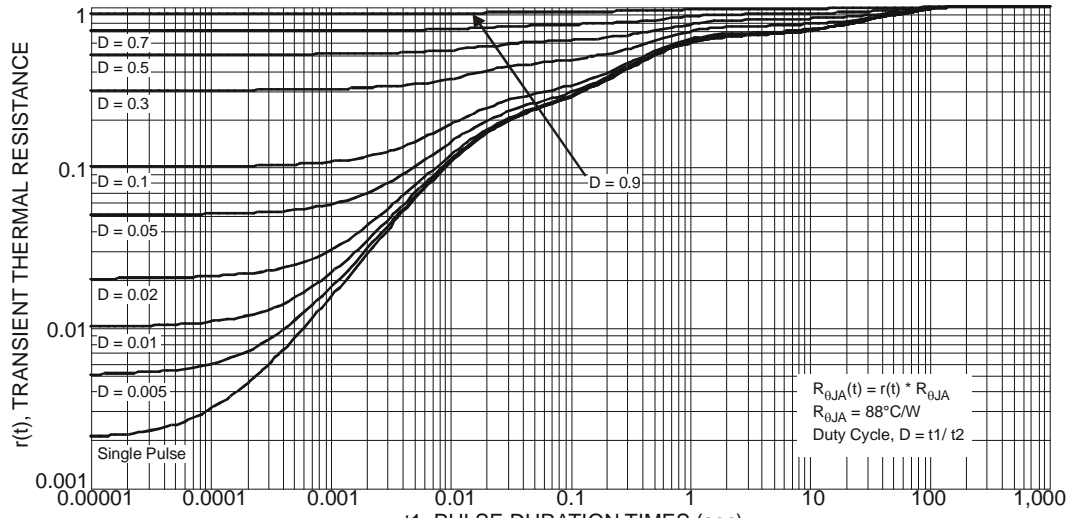
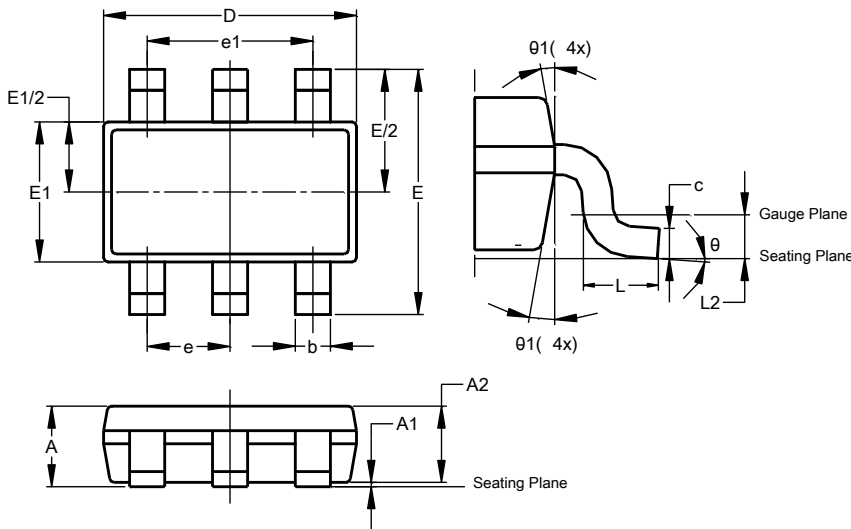


Fig. 13 Transient Thermal Resistance

Package Outline Dimensions

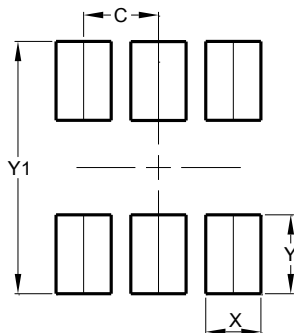
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| TSOT26 | | | |
|-----------------------------|-----------|-------|-------|
| Dim | Min | Max | Typ |
| A | — | 1.00 | — |
| A1 | 0.010 | 0.100 | — |
| A2 | 0.840 | 0.900 | — |
| D | 2.800 | 3.000 | 2.900 |
| E | 2.800 BSC | | |
| E1 | 1.500 | 1.700 | 1.600 |
| b | 0.300 | 0.450 | — |
| c | 0.120 | 0.200 | — |
| e | 0.950 BSC | | |
| e1 | 1.900 BSC | | |
| L | 0.30 | 0.50 | — |
| L2 | 0.250 BSC | | |
| theta | 0° | 8° | 4° |
| theta1 | 4° | 12° | — |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.950 |
| X | 0.700 |
| Y | 1.000 |
| Y1 | 3.199 |

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